

1.本站收集的数据手册和产品资料都来自互联网,版权归原作者所有。如读者和版权方有任 何异议请及时告之,我们将妥善解决。

本站提供的中文数据手册是英文数据手册的中文翻译,其目的是协助用户阅读,该译文无法自动跟随原稿更新,同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。

3.本站提供的产品资料,来自厂商的技术支持或者使用者的心得体会等,其内容可能存在描 叙上的差异,建议读者做出适当判断。

4.如需与我们联系,请发邮件到marketing@iczoom.com,主题请标有"数据手册"字样。

# **Read Statement**

1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.

2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.

3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.

4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets".

### GaN on SiC HEMT Pulsed Power Transistor 125 W Peak, 960-1215 MHz, 128 µs Pulse, 10% Duty

#### Features

- GaN on SiC Depletion-Mode Transistor Technology
- Internally Matched
- Common-Source Configuration
- Broadband Class AB Operation
- RoHS\* Compliant and 260 °C Reflow Compatible
- +50 V Typical Operation
- MTTF = 600 years (T<sub>J</sub> < 200 °C)</li>

#### Applications

- Civilian Air Traffic Control (ATC), L-Band Secondary Radar for IFF and Mode-S Avionics.
- Military radar for IFF and Data Links.

#### Description

The MAGX-000912-500L00 is a gold metalized matched Gallium Nitride (GaN) on Silicon Carbide RF power transistor optimized for civilian and military pulsed avionics amplifier applications for the 960 MHz to 1215 MHz range such as Mode-S, TCAS, JTIDS, DME and TACAN. Using state of the art wafer fabrication processes, these high performance transistors provide high gain, efficiency, bandwidth, ruggedness over a wide bandwidth for today's demanding application needs. High breakdown voltages allow for reliable and stable operation in extreme mismatched load conditions unparalleled with older semiconductor technologies.



#### **Ordering Information**

Part Number	Description
MAGX-000912-125L00	125W GaN Power Transistor
MAGX-000912-SB0PPR	Evaluation Test Fixture

#### Typical RF Performance under Standard Operating Conditions, Pout = 125 W (Peak)

Freq (MHz)	P <sub>IN</sub> (W)	Gain (dB)	І <sub>D</sub> (А)	Eff. (%)	RL (dB)	Droop (dB)	VSWR-S (5:1)	VSWR-T (10:1)
960	1.4	19.7	3.9	64.4	-6.1	0.3	S	Р
1030	1.3	19.8	4.0	61.6	-11.9	0.3	S	Р
1090	1.6	18.9	4.1	60.4	-9.6	0.3	S	Р
1150	1.7	18.6	4.1	61.4	-9.3	0.3	S	Р
1215	1.6	18.9	4.0	61.9	-12.0	0.3	S	Р

\* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



Rev. V3



### GaN on SiC HEMT Pulsed Power Transistor 125 W Peak, 960-1215 MHz, 128 µs Pulse, 10% Duty

Rev. V3

### Electrical Specifications: Freq. = 960 - 1215 MHz, T<sub>A</sub> = 25°C

Parameter	meter Test Conditions		Min.	Тур.	Max.	Units
RF Functional Tests						
Peak Input Power		P <sub>IN</sub>	-	1.2	2.2	W
Power Gain	V <sub>DD</sub> = 50 V, I <sub>DQ</sub> = 100 mA, Pulse Width = 128 μs, Duty Cycle = 10%, P <sub>OUT</sub> = 125 W Peak (12.5 W avg.)	G <sub>P</sub>	17.5	19.2	-	dB
Drain Efficiency		$\eta_{D}$	57	62	-	%
Load Mismatch Stability		VSWR-S	-	5:1	-	-
Load Mismatch Tolerance		VSWR-T	-	10:1	-	-

## Electrical Characteristics: T<sub>A</sub> = 25°C

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units	
DC Characteristics	DC Characteristics						
Drain-Source Leakage Current	$V_{GS}$ = -8 V, $V_{DS}$ = 175 V	I <sub>DS</sub>	-	0.2	6	mA	
Gate Threshold Voltage	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 15 mA	V <sub>GS (TH)</sub>	-5	-3.8	-2	V	
Forward Transconductance	$V_{DS}$ = 5 V, I <sub>D</sub> = 3.5 mA	G <sub>M</sub>	2.5	3.6	-	S	
Dynamic Characteristics							
Input Capacitance	Not applicable - Input matched	CISS	N/A	N/A	N/A	pF	
Output Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = -8 V,	C <sub>oss</sub>	-	11	-	pF	
Reverse Transfer Capacitance	Freq. = 1 MHz	C <sub>RSS</sub>	-	1.1	-	pF	



### GaN on SiC HEMT Pulsed Power Transistor 125 W Peak, 960-1215 MHz, 128 µs Pulse, 10% Duty

Rev. V3

## Absolute Maximum Ratings<sup>1,2,3</sup>

Parameter	Limit
Drain Voltage (V <sub>DD</sub> )	+65 V
Gate Voltage (V <sub>GG</sub> )	-8 to -2 V
Drain Current (I <sub>DD</sub> )	9.5 A
Input Power <sup>4</sup> (P <sub>IN</sub> )	P <sub>IN</sub> (nominal) + 3 dB
Operating Junction Temperature <sup>5</sup>	250 °C
Peak Pulsed Power Dissipation at 85 °C	350 W
Operating Temperature Range	-40 to +95 °C
Storage Temperature Range	-65 to +150 °C
ESD Maximum - Machine Model (MM)	50 V
ESD Maximum - Human Body Model (HBM)	250 V

1. Exceeding any one or combination of these limits may cause permanent damage to this device.

2. MACOM does not recommend sustained operation near these survivability limits.

3. For saturated performance it is recommended that the sum of ( $3 * V_{DD} + |V_{GG}|$ ) < 175 V.

4. Input Power Limit is +3 dB over nominal drive required to achieve Pout = 125 W.

5. Operating junction temperature is measured with infrared (IR) microscope. Junction temperature directly affects a device's MTTF and should be kept as low as possible to maximize lifetime.

MTTF =  $5.3 \times 10^6$  hours (T<sub>J</sub> < 200 °C) •

MTTF =  $6.8 \times 10^4$  hours (T<sub>J</sub> <  $250 \degree$ C) •

#### **Thermal Characteristics**

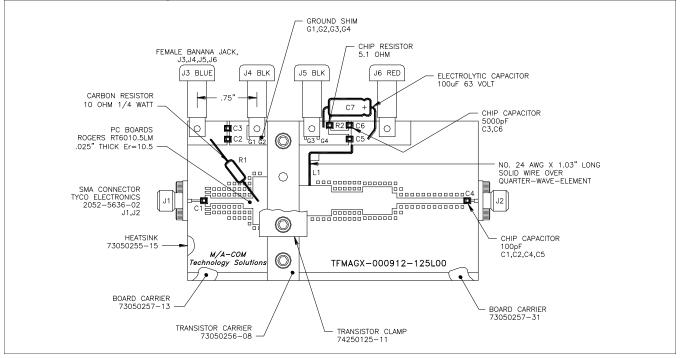
Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance	$T_{C}$ = 70 °C, $V_{DD}$ = 50 V, $I_{DQ}$ = 100 mA, $P_{OUT}$ = 125 W, Pulse Width = 128 µs, Duty Cycle = 10%	$\Theta_{JC}$	0.5	°C/W



### GaN on SiC HEMT Pulsed Power Transistor 125 W Peak, 960-1215 MHz, 128 µs Pulse, 10% Duty

Rev. V3

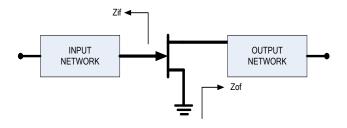
#### **Test Fixture Assembly**



Contact MACOM for additional circuit information.

Freq. (MHz)	Z <sub>IF</sub> (Ω)	Z <sub>OF</sub> (Ω)			
960	3.9 - j7.5	7.6 + j2.6			
1030	3.7 - j6.6	8.3 + j1.5			
1090	3.6 - j5.6	8.2 + j0.8			
1150	4.7 - j6.0	8.0 + j0.6			
1215	4.1 - j5.5	8.2 + j0.9			

#### **Test Fixture Impedances**



#### **Correct Device Sequencing**

#### Turning the device ON

- 1. Set  $V_{GS}$  to the pinch-off ( $V_P$ ), typically -5 V.
- 2. Turn on  $V_{DS}$  to nominal voltage (50 V).
- 3. Increase  $V_{GS}$  until the  $I_{DS}$  current is reached.
- 4. Apply RF power to desired level.

#### Turning the device OFF

- 1. Turn the RF power off.
- 2. Decrease  $V_{GS}$  down to  $V_{P.}$
- 3. Decrease V<sub>DS</sub> down to 0 V.
- 4. Turn off  $V_{GS}$

4

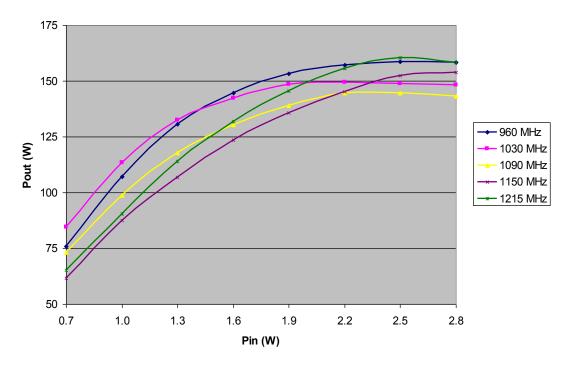
M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



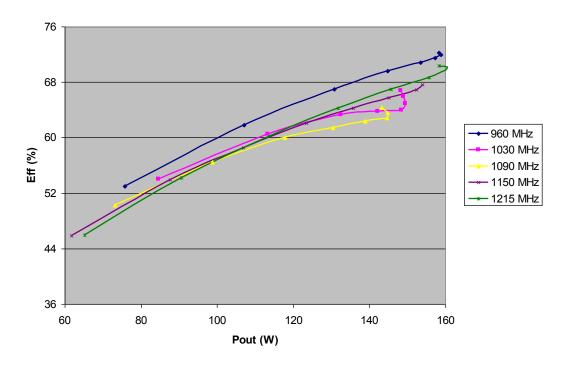
### GaN on SiC HEMT Pulsed Power Transistor 125 W Peak, 960-1215 MHz, 128 µs Pulse, 10% Duty

Rev. V3





RF Power Transfer Curve (Drain Efficiency Vs. Output Power)

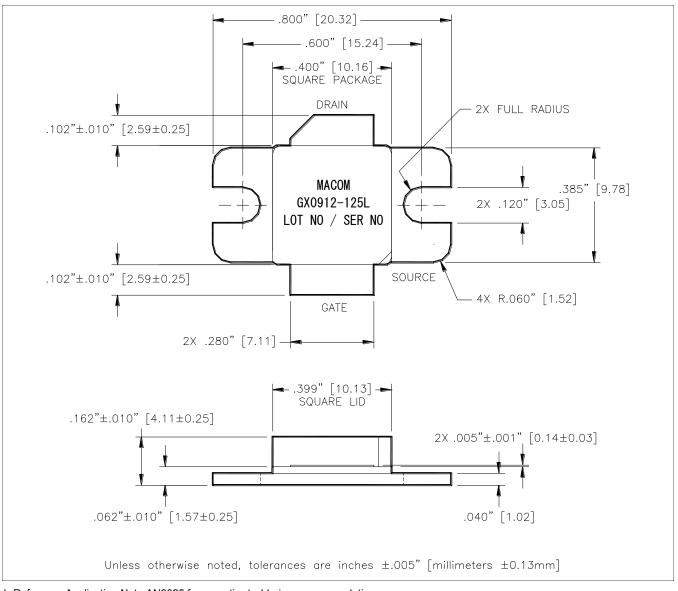


5

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



#### **Outline Drawing<sup>†</sup>**



† Reference Application Note AN3025 for mounting/soldering recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is Ni/Au.

For further information and support please visit: <u>https://www.macom.com/support</u>

Rev. V3







GaN on SiC HEMT Pulsed Power Transistor 125 W Peak, 960-1215 MHz, 128 µs Pulse, 10% Duty

Rev. V3

M/A-COM Technology Solutions Inc. All rights reserved.

Information in this document is provided in connection with M/A-COM Technology Solutions Inc ("MACOM") products. These materials are provided by MACOM as a service to its customers and may be used for informational purposes only. Except as provided in MACOM's Terms and Conditions of Sale for such products or in any separate agreement related to this document, MACOM assumes no liability whatsoever. MACOM assumes no responsibility for errors or omissions in these materials. MACOM may make changes to specifications and product descriptions at any time, without notice. MACOM makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions. No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. MACOM FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. MACOM SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.

For further information and support please visit: <u>https://www.macom.com/support</u>

7